

HC49US Series



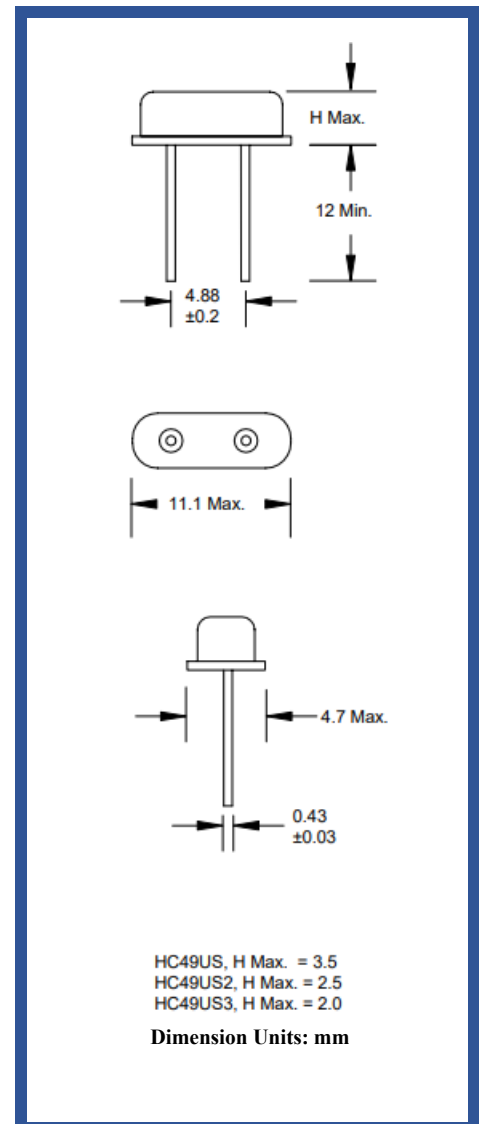
Product Feature:

Low Cost Package
RoHs Compliant
Compatible with Leadfree Processing

Applications:

Fibre Channel
Server & Storage
Sonet /SDH
802.11 / Wifi
T1/E1.T3/E3
System Clock

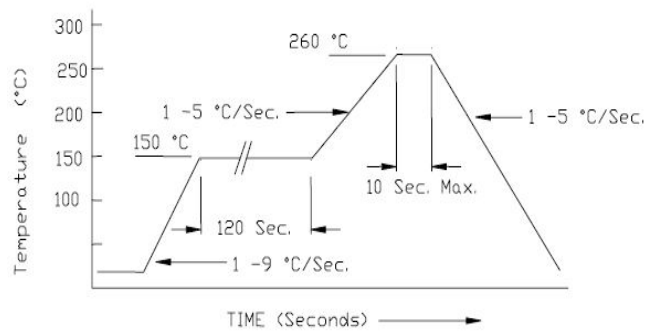
Frequency	3.2 MHz to 100 MHz
ESR (Equivalent Series Resistance)	
3.2 MHz - 3.49 MHz	300 Ω Max.
3.5 MHz - 3.99 MHz	200 Ω Max.
4.0 MHz - 4.99 MHz	150 Ω Max.
5.0 MHz - 5.99 MHz	120 Ω Max.
6.0 MHz - 6.99 MHz	100 Ω Max.
7.0 MHz - 8.9 MHz	80 Ω Max.
9.0 MHz - 12.9 MHz	60 Ω Max.
13 MHz - 19.9 MHz	40 Ω Max.
20 MHz - 36 MHz	30 Ω Max.
27 MHz - 100.0 MHz (3rd O.T.)	100 Ω Max.
Shunt Capacitance (C0)	7 pF Max.
Frequency Tolerance @ 25° C	±30 ppm Standard (see Part Number Guide for more options)
Frequency Stability over Temperature	±50 ppm Standard (see Part Number Guide for more options)
Crystal Cut	AT Cut
Load Capacitance	18 pF Standard (see Part Number Guide for more options)
Drive Level	1 mW Max.
Aging	±5 ppm Max. / Year Standard
Temperature	
Operating	0° C to +70° C Standard (see Part Number Guide for more options)
Storage	-40° C to +85° C Standard



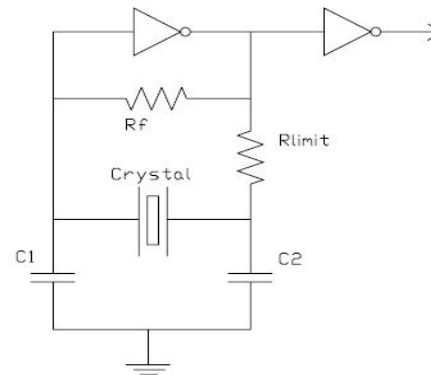
Part Number Guide						
Sample Part Number: HC49USM - FB1F18 - 20.000						
Package	Tolerance (ppm) at Room Temperature	Stability (ppm) over Operating Temperature	Operating Temperature Range	Mode (overtone)	Load Capacitance (pF)	Frequency
HC49US- (3.5 mm H)	B = ±50ppm	B = ±50ppm	0 = 0°C to +50°C	F = Fundamental	18pF Standard Or Specify	-20.000 MHz
HC49US2- (2.5 mm H)	F = ±30ppm	F = ±30ppm	1 = 0°C to +70°C	3 = Third Overtone		
HC49US3- (2.0 mm H)	G = ±25ppm	G = ±25ppm	2 = -10°C to +60°C			
	H = ±20ppm	H = ±20ppm	3 = -20°C to +70°C			
	I = ±15ppm	I = ±15ppm	5 = -40°C to +85°C			
	J = ±10ppm*	J = ±10ppm	9 = -10°C to +50°C			

* Not available at all frequencies. ** Not available for all temperature ranges.

Pb Free Solder Reflow Profile:



Typical Circuit:



*Units are backward compatible with 240C reflow processes

Package Information:

MSL = 1

Termination = e4 (Sn / Cu/ Ag over Ni over Kovar base metal).

Environmental Specifications:

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition B
Mechanical Vibration	MIL-STD-883, Method 2007, Condition A
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS / Green Compliant
Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10 ⁻⁸ atm cc/s
Solvent Resistance	MIL-STD-202, Method 215

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ABRACON:

[HC49US-FF5F18-20.000MHz](#) [HC49US-FF5F18-8.000MHz](#) [HC49US-FF5F18-24.000MHz](#) [HC49US-FF5F18-12.000MHz](#) [HC49US-FF5F18-27.000MHz](#) [HC49US-FF3F18-11.0592MHz](#) [HC49US-FF3F18-12.000MHz](#) [HC49US-FF3F18-6.144MHz](#) [HC49US-FF3F18-18.432MHz](#) [HC49US-FF3F18-4.096MHz](#) [HC49US-FF5F18-3.6864MHz](#) [HC49US-FF3F18-3.6864MHz](#) [HC49US-FF3F18-27.000MHz](#) [HC49US-FF3F18-16.000MHz](#) [HC49US-FF5F18-16.000MHz](#) [HC49US-FF3F18-14.7456MHz](#) [HC49US-FF5F18-14.31818MHz](#) [HC49US-FF3F18-25.000MHz](#) [HC49US-FF3F18-20.000MHz](#) [HC49US-FF5F18-18.432MHz](#) [HC49US-FF5F18-4.9152MHz](#) [HC49US-FF3F18-24.000MHz](#) [HC49US-FF5F18-10.000MHz](#) [HC49US-FF3F18-10.000MHz](#) [HC49US-FF5F18-14.7456MHz](#) [HC49US-FF3F18-7.3728MHz](#) [HC49US-FF5F18-6.000MHz](#) [HC49US-FF5F18-11.0592MHz](#) [HC49US-FF3F18-14.31818MHz](#) [HC49US-FF3F18-4.9152MHz](#) [HC49US-FF5F18-4.000MHz](#) [HC49US-FF3F18-6.000MHz](#) [HC49US-FF3F18-8.000MHz](#) [HC49US-FF3F18-4.000MHz](#) [HC49US-FF5F18-6.144MHz](#) [HC49US-FF5F18-4.096MHz](#) [HC49US-FF5F18-25.000MHz](#) [HC49US-FF5F18-7.3728MHz](#) [HC49US-FF5F18-6.1440MHz](#) [HC49US-FF3F18-18.4320MHz](#) [HC49US-FF5F18-18.4320MHz](#) [HC49US-FF5F18-4.0960MHz](#) [HC49US-FB1F18-32.256MHZ](#)